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PATENT APPLICATION

ATTY. DOCKET NO. SERIAL NO. FORM PTO-1449 10/684,884 10005103-3 LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT APPLICANT'S INFORMATION DISCLOSURE BASH et al. STATEMENT FILING DATE GROUP (Use several sheets if necessary) October 13, 2003 REFERENCE DESIGNATION **U.S. PATENT DOCUMENTS** SUB EXAMINER DOCUMENT DATE NAME CLASS CLASS INITIAL NUMBER 132 Patel et al. 62 6,205,799 B1 Mar. 27, 2001 M · Takahashi et al. 165 104.33 Feb. 6, 2001 6,182,742 B1 Aug. 22, 2000 6,108,201 Tilton et al. 361 689 361 699 Aug. 24, 1999 Havey et al. 5,943,211 890.1 29 Swanson et al. 5,924,198 Jul. 20, 1999 Przilas et al. 361 699 May 25, 1999 5,907,473 171 5,724,824 Mar. 10 1998 Parsons 62 64 62 McDunn et al. 5,718,117 Feb. 17, 1998 347 45 Hindagolla et al. Jul. 18, 1995 5,434,606 140 R Keefe et al. 346 Jan. 11, 1994 5,278,584 62 64 14 5,220,804 Jun. 22, 1993 Tilton et al. FOREIGN PATENT DOCUMENTS TRANSLATION SUB NAME DOCUMENT DATE CLASS CLASS YES NO NUMBER OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.) Sehmbey, M.S., Pais, M.R. and Chow, L.C., "Effect of Surface Material Properties and Surface Characteristics in Evaporative Spray Cooling," THE JOURNAL OF THERMOPHYSICS & HEAT TRANSFER, July-September, 1992, Vol. 6, No. 3, pp 505-511. Pais, Martin R., Chang, Ming J., Morgan, Michael J. and Chow, Louis C., "Spray Cooling of a High Power Laser Diode, SAE AEROSPACE ATLANTA CONFERENCE & EXPOSITION, DAYTON, OHIO, 1994, pp 1-6. Morgan, Michael J., Chang, Won S., Pals, Martin R. and Chow, Louis C., "Comparison of High Heat-Flux Cooling Applications," SPIE, 1992, Vol. 1739, pp17-28 DATE CONSIDERED **EXAMINER**

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